

**RESPONSE UNDER 37 C.F.R. § 1.116  
EXPEDITED PROCEDURE  
GROUP ART UNIT 2834**

**CERTIFICATE OF FACSIMILE TRANSMISSION**

I hereby certify that this correspondence is being transmitted to Group Art Unit 2834, 703-672-6318, addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231

Date: January 14, 2002

  
Christopher A. Bennett

# 9/B (A)  
Hawkins  
1/18/02

PATENT  
36856.345

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Masaya WAJIMA et al.

Art Unit: 2834

Serial No.: 09/656,106

Examiner: J. Gonzalez

Filed: September 6, 2000

FAX COPY RECEIVED

Title: CHIP ELECTRONIC COMPONENT  
AND MOUNTING STRUCTURE OF THE  
SAME

JAN 14 2002

TECHNOLOGY CENTER 2800

**AMENDMENT AFTER FINAL REJECTION**

Assistant Commissioner for Patents  
Washington, D.C. 20231

Sir:

In response to the Office Action dated November 8, 2001, please amend the above-identified application as follows:

**IN THE CLAIMS:**

Please replace claims 1, 13 and 14 with the following claims:

1. A chip electronic component comprising:  
a body having outer peripheral surfaces including an upper surface, a lower surface and a pair of side surfaces;

B  
SUB  
CL